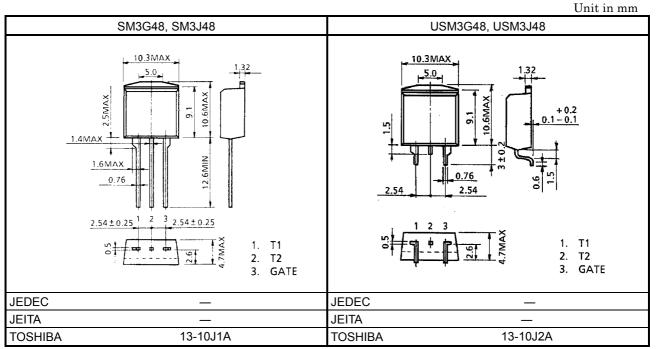
查询"SM3J483供应商BI-DIRECTIONAL TRIODE THYRISTOR SILICON PLANAR TYPE

# SM3G48,USM3G48,SM3J48,USM3J48

AC POWER CONTROL APPLICATIONS

- : V<sub>DRM</sub>=400, 600V • Repetitive Peak Off-State Voltage
  - **R.M.S On-State Current**
- : IT (RMS)=3A
- Gate Trigger Current
- : IGT=20mA Max.



Weight: 1.7g

#### MARKING

	NUMBER		SYMBOL	MARK		
	*1	TYPE	SM3G48, USM3G48	M3G48		
	I		SM3J48, USM3J48	M3J48		
	*2	1	mber Month (Starting from Alphabet A) Year (Last Decimal Digit of the Year of Manufacture)	Example 8A : January 1998 8B : Febrary 1998 8L : December 1998		

## MAXIMUMAR AT MAR S

CHARACTERI	STIC	SYMBOL	RATING	UNIT	
Repetitive Peak	(U)SM3G48	Vanu	400	V	
Off-State Voltage	(U)SM3J48	V <sub>DRM</sub>	600	v	
R.M.S On-State Current		I <sub>T (RMS)</sub>	3	А	
Peak One Cycle Surge On-State Current (Non-Repetitive)		Irou	30 (50Hz)	А	
		ITSM	33 (60Hz)	A	
I <sup>2</sup> t Limit Value		l <sup>2</sup> t	4.5	A <sup>2</sup> s	
Critical Rate of Rise of C Current	0n-State (Note 1)	di / dt	50	A / μs	
Peak Gate Power Dissip	ation	P <sub>GM</sub>	5	W	
Average Gate Power Dis	sipation	P <sub>G (AV)</sub>	0.5	W	
Peak Forward Gate Voltage		V <sub>GM</sub>	10	V	
Peak Forward Gate Curr	rent	I <sub>GM</sub>	2	А	
Junction Temperature		Тј	-40~125	°C	
Storage Temperature Ra	ange	T <sub>stg</sub>	-40~125	°C	

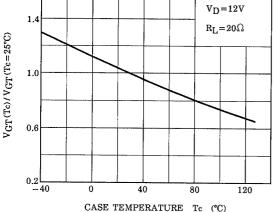
Note 1 :  $V_{DRM}$ =0.5×Rated  $I_{TM}$ ≤4.5A  $t_{gw}$ ≥10 $\mu$ s  $t_{gr}$ ≤250ns  $i_{gp}$ =I<sub>GT</sub>×2.0

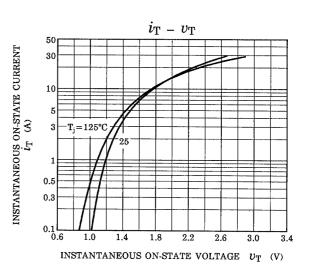
### ELECTRICAL CHARACTERISTICS (Ta=25°C)

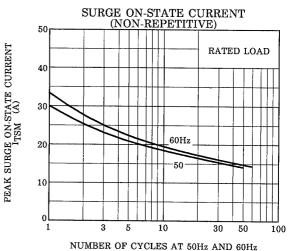
CHARACTERISTIC		SYMBOL	TEST CONDITION		MIN.	TYP.	MAX.	UNIT
Repetitive Peak Off-State Current		I <sub>DRM</sub>	V <sub>DRM</sub> =Rated		—	—	20	μA
Gate Trigger Voltage	Ι		V <sub>D</sub> =12V R <sub>L</sub> =20Ω	T2 (+), Gate (+)	_	_	1.5	- V
	Ш	V <sub>GT</sub>		T2 (+), Gate (-)	_		1.5	
	III			T2 (-), Gate (-)	_	_	1.5	
	IV			T2 (-), Gate (+)	_	_	_	
Gate Trigger Current	I	I <sub>GT</sub>	V <sub>D</sub> =12V R <sub>L</sub> =20Ω	T2 (+), Gate (+)	_	_	20	mA
	Ш			T2 (+), Gate (-)	_	_	20	
	III			T2 (-), Gate (-)	_	_	20	
	IV			T2 (-), Gate (+)	—	_	_	
Peak On-State Voltage		V <sub>TM</sub>	I <sub>TM</sub> =4.5A		_	_	1.5	V
Gate Non-Trigger Voltage		V <sub>GD</sub>	V <sub>D</sub> =Rated, Tc=125°C		0.2	_	_	V
Holding Current		Ι <sub>Η</sub>	V <sub>D</sub> =12V, I <sub>TM</sub> =1A		_	_	30	mA
Thermal Resistance		R <sub>th (j-c)</sub>	Junction to Case, AC		_	_	3.6	°C/W
Critical Rate of Rise of Off-State Voltage		dv / dt	V <sub>DRM</sub> =Rated, T <sub>j</sub> =125°C Exponential Rise		_	300	_	V / μs
Critical Rate of Rise of Off-State Voltage at Commutation		(dv / dt) c	V <sub>DRM</sub> =400V, Tj=125°C (di /dt) c=–2.0A / ms		10	_	_	V / μs

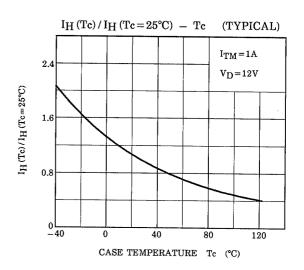
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#### GATE TRIGGER CHARACTERISTIC 50 30 INSTANTANEOUS GATE VOLTAGE UG (V) $V_{GM} = 10V$ $P_{GM} = 5W$ 10 $25^{\circ}C V_{GT}$ 5 =0.5VG(AV) -40°C V<sub>GT</sub> 3 25°C IGT 0.5 -40°C IGT IGM=2A 0.3 $V_{GD} = 0.2V$ 0.1 1000 1 10 100 Instantaneous gate current $i_{ m G}$ (V) $I_{GT}(T_c)/I_{GT}(T_c=25^{\circ}C) - T_c$ (TYPICAL) $V_D = 12V$ 3 $R_L = 20\Omega$ (GT (Te) / IGT (Te = 25°C))IGT(II) I<sub>GT</sub>(I, Ⅱ) 0 -40 0 40 80 120 CASE TEMPERATURE Tc (°C) $V_{GT}$ (Tc) / $V_{GT}$ (Tc = 25°C) – Tc (TYPICAL) $V_D = 12V$ 1.4



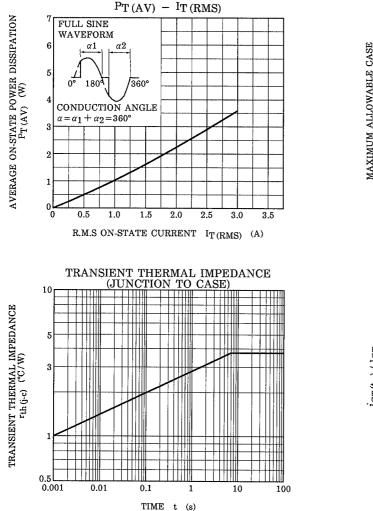


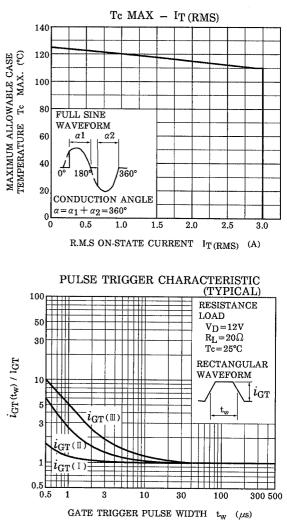






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